MITSUBISHI SEMICONDUCTOR <GaAs FET>

MGFC39V4450A

4.4 ~ 5.0GHz BAND 8W INTERNALLY MATCHED GaAs FET

DESCRIPTION

The MGFC39V4450A is an internally impedance-matched GaAs power FET especially designed for use in 4.4 ~ 5.0 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

FEATURES

Class A operation Internally matched to 50(ohm) system High output power P1dB = 8W (TYP.) @ f=4.4~5.0GHz High power gain GLP = 11.5 dB (TYP.) @ f=4.4~5.0GHz High power added efficiency P.A.E. = 30 % (TYP.) @ f=4.4~5.0GHz Low distortion [item -51] IM3= -45 dBc(TYP.) @ Po=28dBm S.C.L.

APPLICATION

item 01 : 4.4~5.0 GHz band power amplifier item 51 : 4.4~5.0 GHz band digital radio communication

QUALITY GRADE

IG

RECOMMENDED BIAS CONDITIONS

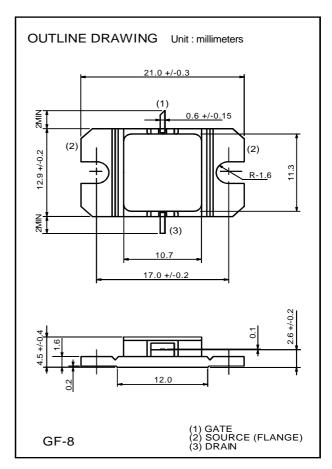
VDS = 10 (V) ID=2.4 (A) Refer to Bias Procedure" RG= 50 (ohm)

ABSOLUTE MAXIMUM RATINGS (Ta=25 deg.C)

Symbol	Parameter	Ratings	Unit
VGDO	Gate to drain voltage	-15	V
VGSO	Gate to source voltage	-15	V
ID	Drain current	7.5	Α
IGR	Reverse gate current	-20	mA
IGF	Forward gate current	42	mA
PT	Total power dissipation *1	42.8	W
Tch	Channel temperature	175	deg.C
Tstg	Storage temperature	-65 / +175	deg.C



ELECTRICAL CHARACTERISTICS



< Keep safety first in your circuit designs! > Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (1)placement of substitutive, auxiliary circuits, (2)use of non-flammable material or (3)prevention against any malfunction or mishap.

ARACTERISTICS	(Ta=25 deg.C)

Parameter	Test conditions	Limits			Unit
Parameter		Min.	Тур.	Max.	Unit
Saturated drain current	VDS=3V, VGS=0V	-	-	7.5	А
Transconductance	VDS=3V, ID=2.2A	-	2	-	S
Gate to source cut-off voltage	VDS=3V, ID=20mA	-	-	-4.5	V
Output power at 1dB gain compression		38	39	-	dBm
Linear power gain	VDS=10V, ID(RF off)=2.4A, f=4.4~5.0GHz	8	11.5	-	dB
Drain current		-	-	3	А
Power added efficiency		-	30	-	%
3rd order IM distortion *1		-42	-45	-	dBc
Thermal resistance *2	Delta Vf method	-	-	3.5	deg.C/W
	Transconductance Gate to source cut-off voltage Output power at 1dB gain compression Linear power gain Drain current Power added efficiency 3rd order IM distortion *1	Saturated drain current VDS=3V, VGS=0V Transconductance VDS=3V, ID=2.2A Gate to source cut-off voltage VDS=3V, ID=20mA Output power at 1dB gain compression VDS=10V, ID(RF off)=2.4A, f=4.4~5.0GHz Drain current Power added efficiency 3rd order IM distortion *1	Saturated drain currentVDS=3V, VGS=0VMin.TransconductanceVDS=3V, ID=2.2A-Gate to source cut-off voltageVDS=3V, ID=20mA-Output power at 1dB gain compression38Linear power gainVDS=10V, ID(RF off)=2.4A, f=4.4~5.0GHz8Drain current-Power added efficiency-3rd order IM distortion *1-42	ParameterTest conditionsMin.Typ.Saturated drain currentVDS=3V, VGS=0VTransconductanceVDS=3V, ID=2.2A-2Gate to source cut-off voltageVDS=3V, ID=20mAOutput power at 1dB gain compression3839Linear power gainVDS=10V, ID(RF off)=2.4A, f=4.4~5.0GHz811.5Drain currentPower added efficiency-303rd order IM distortion *1-42-45	ParameterTest conditionsMin.Typ.Max.Saturated drain currentVDS=3V, VGS=0V7.5TransconductanceVDS=3V, ID=2.2A-2-Gate to source cut-off voltageVDS=3V, ID=20mA4.5Output power at 1dB gain compression3839-Linear power gainVDS=10V, ID(RF off)=2.4A, f=4.4~5.0GHz811.5-Drain current-30-30Power added efficiency42-45-

*1 : item -51, 2 tone test, Po=28dBm Single Carrier Level, f=5GHz, Delta f=10MHz

*2 : Channel to case



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